

2A, 50V - 1000V Surface Mount Fast Recovery Rectifiers

FEATURES

- Low power loss, high efficiency
- Ideal for automated placement
- Glass passivated junction chip.
- Fast switching for high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition
- AEC-Q101 qualified

MECHANICAL DATA

Case: DO-214AA (SMB)

Molding compound, UL flammability classification rating 94V-0 Packing code with suffix "G" means green compound (halogen-free) Moisture sensitivity level: level 1, per J-STD-020 **Terminal:** Matte tin plated leads, solderable per JESD22-B102 Meet JESD 201 class 2 whisker test **Polarity:** Indicated by cathode band **Weight:** 0.09 g (approximately)







DO-214AA (SMB)

PARAMETER	SYMBOL	RS	RS	RS	RS	RS	RS	RS	UNIT
		2A	2B	2D	2G	2J	2K	2M	
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	I _{F(AV)}	2				А			
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	50					A		
Maximum instantaneous forward voltage (Note 1) I_F = 2 A	V _F	1.3					V		
Maximum reverse current @ rated VR T _J =25 °C T _J =125 °C	I _R	5 50				μA			
Maximum reverse recovery time (Note 2)	t _{rr}	150 250 500		00	ns				
Typical junction capacitance (Note 3)	CJ	50				pF			
Typical thermal resistance	$R_{_{ extsf{ heta}JL}}$ $R_{_{ hetaJA}}$	18 55				°C/W			
Operating junction temperature range	TJ	- 55 to +150					°C		
Storage temperature range	T _{STG}	- 55 to +150					°C		

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Reverse Recovery Test Conditions: I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

Note 3: Measured at 1 MHz and Applied V_R =4.0 Volts



ORDER INFORMATION (EXAMPLE)



Green compound codePacking code

Part no.

RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)

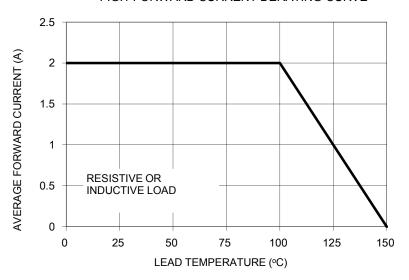
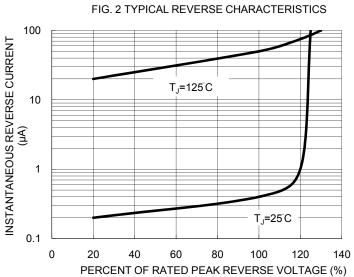
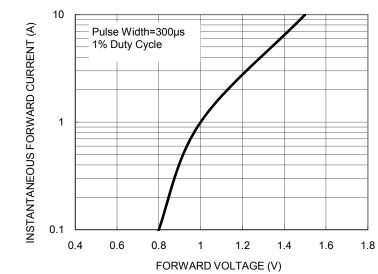
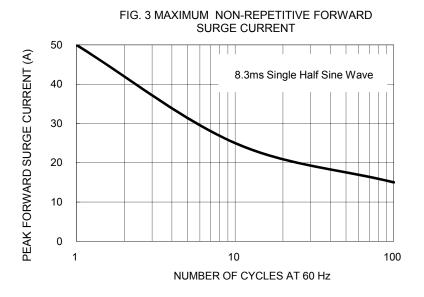


FIG.1 FORWARD CURRENT DERATING CURVE FIG.









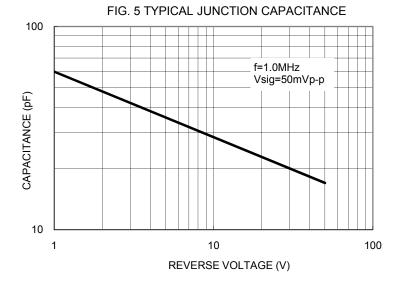
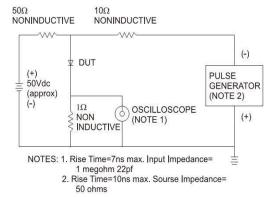
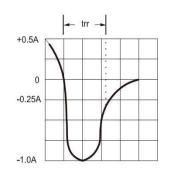
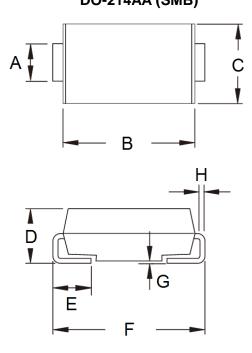


FIG.6 REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM



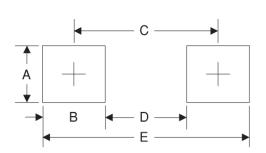


PACKAGE OUTLINE DIMENSIONS DO-214AA (SMB)



Unit (inch) Unit (mm) DIM. Min Max Min Max 1.95 2.10 0.077 0.083 А В 4.25 4.75 0.167 0.187 С 3.48 3.73 0.137 0.147 D 1.99 2.61 0.078 0.103 Е 0.90 0.035 0.056 1.41 F 5.10 5.30 0.201 0.209 G 0.004 0.008 0.10 0.20 Н 0.15 0.006 0.012 0.31

SUGGESTED PAD LAYOUT



P/N

YW

G

F

Symbol	Unit (mm)	Unit (inch)		
A	2.3	0.091		
В	2.5	0.098		
С	4.3	0.169		
D	1.8	0.071		
E	6.8	0.268		

MARKING DIAGRAM



- = Specific Device Code
- = Green Compound
- = Date Code
- = Factory Code



Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or seling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Taiwan Semiconductor: RS2J R5G RS2G R5G RS2K R5G RS2M R5G RS2B R5G RS2A R5G RS2D R5G